

10/582994 14 JUN 2006

APPLICATION DATA SHEET

Application Information

Application number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?:: None

Number of CD disks::

Number of copies of CDs::

Sequence submission?::

Computer Readable Form (CRF)?:: No

Number of copies of CRF::

Title :: DIELECTRIC PASTE FOR SPACER LAYER OF
A MULTI-LAYERED CERAMIC ELECTRONIC
COMPONENT

Attorney Docket Number:: 890050.543USPC

Request for Early Publication?:: No

Request for Non-Publication?:: No

Suggested Drawing Figure::

Total Drawing Sheets::

Small Entity?:: No

Petition included?:: No

Petition Type::

Licensed U.S. Gov't Agency::

Contract or Grant No::

Secrecy Order in Parent Appl.?:: No

First Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Shigeki
Middle Name::	
Family Name::	Satou
Name Suffix::	
City of Residence::	Tokyo
State or Province of Residence::	
Country of Residence::	Japan
Street of mailing address::	c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku
City of mailing address::	Tokyo
State or Province of mailing address::	
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	103-8272

Second Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Takeshi
Middle Name::
Family Name:: Nomura
Name Suffix::
City of Residence:: Tokyo
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City of mailing address:: Tokyo
State or Province of mailing address::
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 103-8272

Correspondence Information

Correspondence Customer Number :: **00500**

Representative Information

Representative Customer Number::		00500
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Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2004/018628	12/14/04

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2003-416158	12/15/03	Yes

Assignee Information

Assignee name::	TDK Corporation
Street of mailing address::	1-13-1, Nihonbashi, Chuo-ku
City of mailing address::	Tokyo
State or Province of mailing address::	
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	103-8272

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